Alfa-MOS Technology

AFC2519W
20V N & P Pair Enhancement Mode MOSFET

General Description

AFC2519W, N & P Pair enhancement mode MOSFET, uses Advanced Trench Technology to provide excellent $R_{DS(ON)}$, low gate charge. These devices are particularly suited for low voltage power management, and low in-line power loss are needed in commercial industrial surface mount applications.

Features

- N-Channel

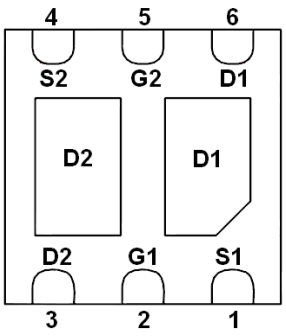
20V/4.5A,$R_{DS(ON)}$=38mΩ@V_{GS}=4.5V
20V/3.6A,$R_{DS(ON)}$=48mΩ@V_{GS}=2.5V
20V/2.4A,$R_{DS(ON)}$=68mΩ@V_{GS}=1.8V

- P-Channel

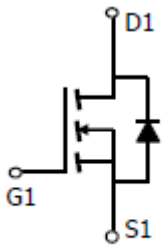
-20V/-4.5A,$R_{DS(ON)}$=80mΩ@V_{GS}=-4.5V
-20V/-3.8A,$R_{DS(ON)}$=105mΩ@V_{GS}=-2.5V
-20V/-2.5A,$R_{DS(ON)}$=145mΩ@V_{GS}=-1.8V

- Super high density cell design for extremely low $R_{DS\ (ON)}$
- Exceptional on-resistance and maximum DC current capability
- DFN2X2-6L package design

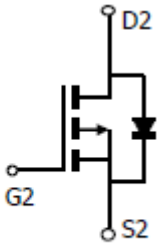
Pin Description (DFN2X2-6L)



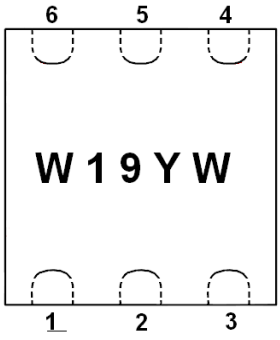
BOTTOM VIEW



n-channel



p-channel



TOP VIEW

Application

- Power Management in Note book
- Portable Equipment
- Battery Powered System
- DC/DC Converter
- Load Switch
- DSC
- LCD Display inverter

Pin Define

Pin	Symbol	Description
1	S1	Source1
2	G1	Gate1
3	D2	Drain2
4	S2	Source2
5	G2	Gate2
6	D1	Drain1

Ordering Information

Part Ordering No.	Part Marking	Package	Unit	Quantity
AFC2519WFN226RG	W19YW	DFN2X2-6L	Tape & Reel	4000 EA

※ Y year code
※ W week code
※ AFC2519WFN226RG : 7" Tape & Reel ; Pb- Free ; Halogen –Free

Absolute Maximum Ratings

(T_A=25℃ Unless otherwise noted)

Parameter		Symbol	Typical		Unit
			N-Channel	P-Channel	
Drain-Source Voltage		V_{DSS}	20	-20	V
Gate –Source Voltage		V_{GSS}	±12	±12	V
Continuous Drain Current(T_J=150℃)	T_A=25℃	I_D	4.5	-4.5	A
	T_A=70℃		2.4	-2.4	
Pulsed Drain Current		I_{DM}	15	-15	A
Continuous Source Current(Diode Conduction)		I_S	1.5	-1.5	A
Power Dissipation	T_A=25℃	P_D	1.9		W
	T_A=70℃		1.2		
Operating Junction Temperature		T_J	150		℃
Storage Temperature Range		T_{STG}	-55/150		℃
Thermal Resistance-Junction to Ambient		$R_{\theta JA}$	65		℃/W

Electrical Characteristics (N-Channel)

(T_A=25℃ Unless otherwise noted)

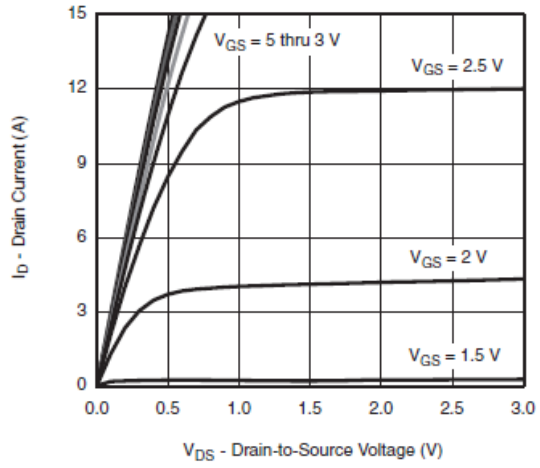
Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
Static						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	V_{GS}=0V,I_D=250uA	20			V
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS}=V_{GS},I_D=250uA	0.3		0.8	
Gate Leakage Current	I_{GSS}	V_{DS}=0V,V_{GS}=±12V			±100	nA
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS}=16V,V_{GS}=0V			1	uA
		V_{DS}=16V,V_{GS}=0V T_J=85℃			10	
On-State Drain Current	$I_{D(on)}$	V_{DS}≧5V,V_{GS}=4.5V	6			A
		V_{DS}≧5V,V_{GS}=2.5V	4			
Drain-Source On-Resistance	$R_{DS(on)}$	V_{GS}=4.5V,I_D=4.5A		28	38	mΩ
		V_{GS}=2.5V,I_D=3.6A		35	48	
		V_{GS}=1.8V,I_D=2.4A		50	68	
Forward Transconductance	g_{FS}	V_{DS}=5V,I_D=3.6A		10		S
Diode Forward Voltage	V_{SD}	I_S=1.6A,V_{GS}=0V		0.85	1.2	V
Dynamic						
Total Gate Charge	Q_g	V_{DS}=10V,V_{GS}=4.5V I_D≡3.6A		4.2	5.0	nC
Gate-Source Charge	Q_{gs}			0.6		
Gate-Drain Charge	Q_{gd}			0.4		
Input Capacitance	C_{iss}	V_{DS}=10V,V_{GS}=0V f=1MHz		340		pF
Output Capacitance	C_{oss}			115		
Reverse Transfer Capacitance	C_{rss}			33		
Turn-On Time	$t_{d(on)}$	V_{DD}=10V,R_L=2.8Ω I_D≡3.6A,V_{GEN}=4.5V R_G=1Ω		8	15	ns
	t_r			8	15	
Turn-Off Time	$t_{d(off)}$			25	40	
	t_f			8	15	

Electrical Characteristics (P-Channel)

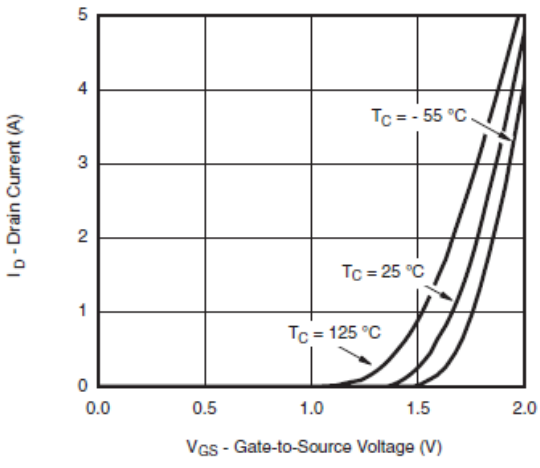
(T_A=25℃ Unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
Static						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	V_{GS}=0V,I_D=-250uA	-20			V
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS}=V_{GS},I_D=-250uA	-0.3		-0.8	
Gate Leakage Current	I_{GSS}	V_{DS}=0V,V_{GS}=±12V			±100	nA
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS}=-16V,V_{GS}=0V			-1	uA
		V_{DS}=-16V,V_{GS}=0V T_J=85℃			-30	
On-State Drain Current	$I_{D(on)}$	V_{DS}≦-5V,V_{GS}=-4.5V	-8			A
		V_{DS}≦-5V,V_{GS}=-2.5V	-3			
Drain-Source On-Resistance	$R_{DS(on)}$	V_{GS}=-4.5V,I_D=-4.5A		60	80	mΩ
		V_{GS}=-2.5V,I_D=-3.8A		80	105	
		V_{GS}=-1.8V,I_D=-2.5A		115	145	
Forward Transconductance	g_{FS}	V_{DS}=-5V,I_D=-2.8A		6.5		S
Diode Forward Voltage	V_{SD}	I_S=-1.25A,V_{GS}=0V		-0.75	-1.3	V
Dynamic						
Total Gate Charge	Q_g	V_{DS}=-10V,V_{GS}=-4.5V I_D≡-3.5A		5	10	nC
Gate-Source Charge	Q_{gs}			0.85		
Gate-Drain Charge	Q_{gd}			1.5		
Input Capacitance	C_{iss}	V_{DS}=-10V,V_{GS}=0V f=1MHz		375		pF
Output Capacitance	C_{oss}			80		
Reverse Transfer Capacitance	C_{rss}			60		
Turn-On Time	$t_{d(on)}$	V_{DD}=-10V,R_L=2.85Ω I_D≡-3.5A,V_{GEN}=-4.5V R_G=1Ω		15	25	ns
	t_r			36	60	
Turn-Off Time	$t_{d(off)}$			25	50	
	t_f			15	25	

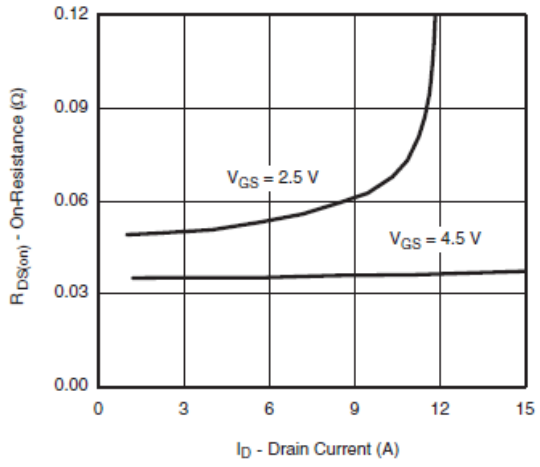
Typical Characteristics (N-Channel)



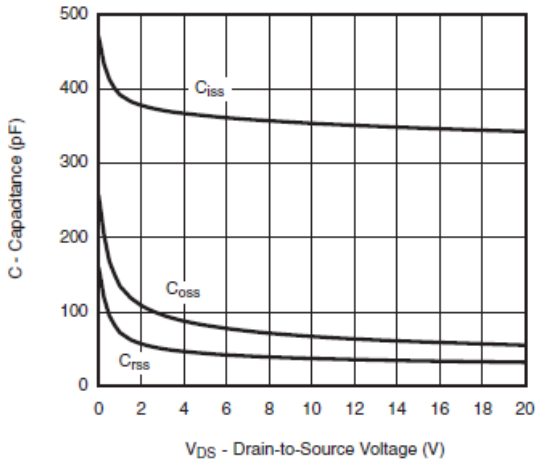
Output Characteristics



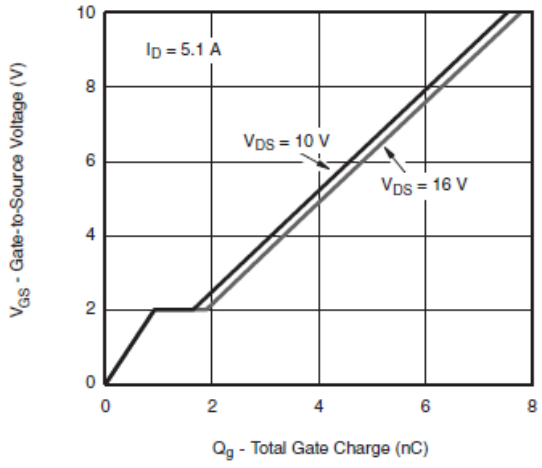
Transfer Characteristics



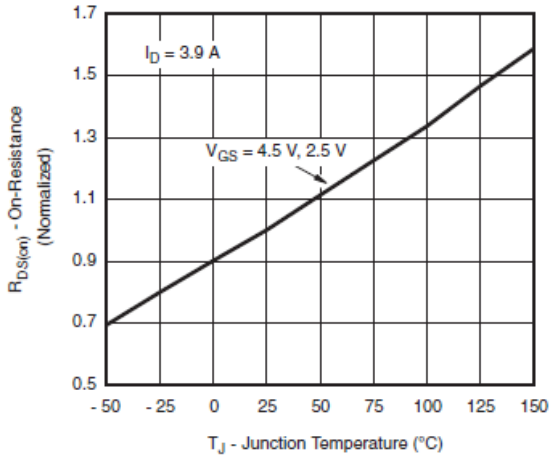
On-Resistance vs. Drain Current and Gate Voltage



Capacitance

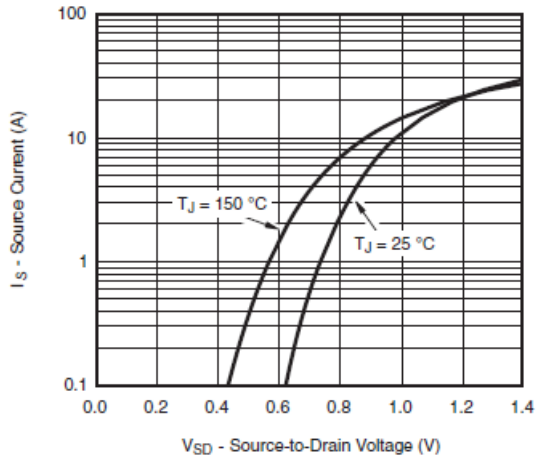


Gate Charge

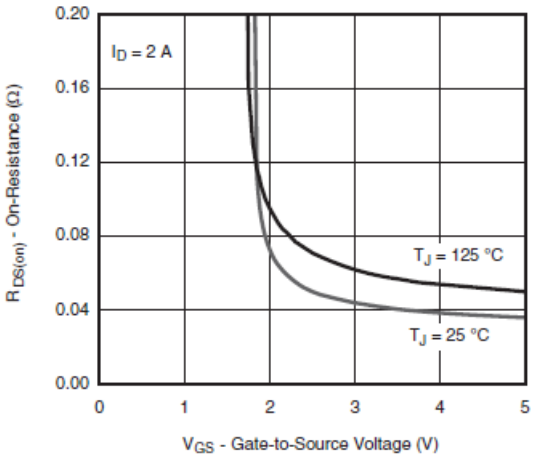


On-Resistance vs. Junction Temperature

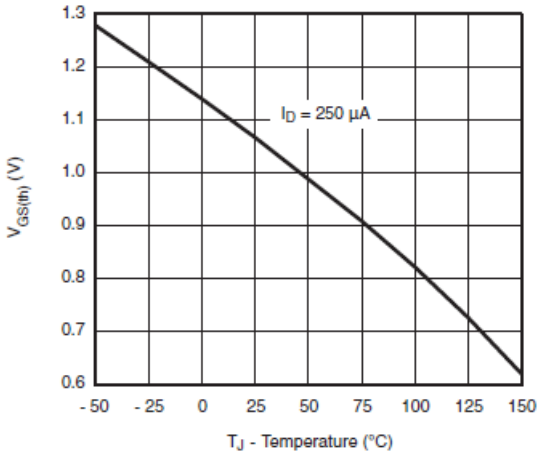
Typical Characteristics (N-Channel)



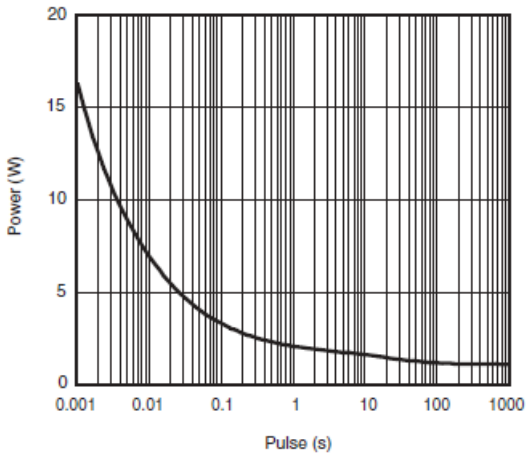
Source-Drain Diode Forward Voltage



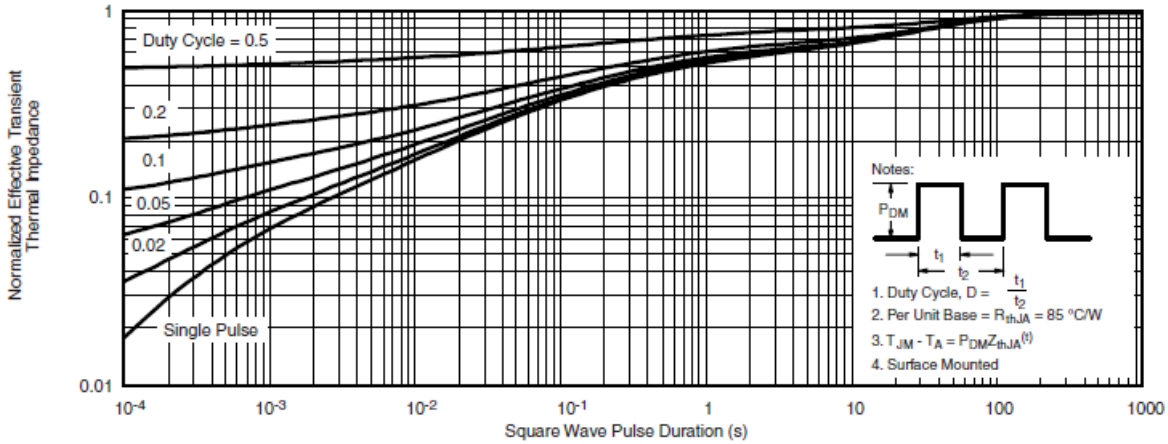
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



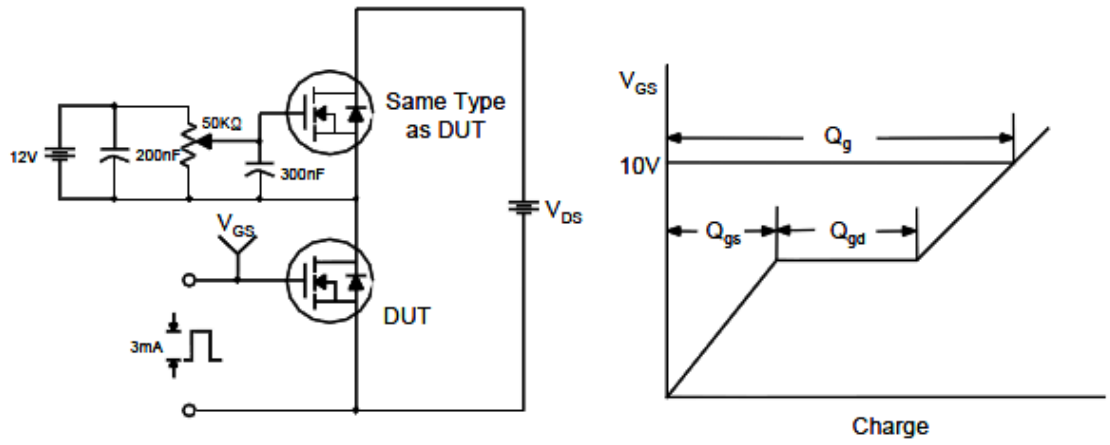
Single Pulse Power (Junction-to-Ambient)



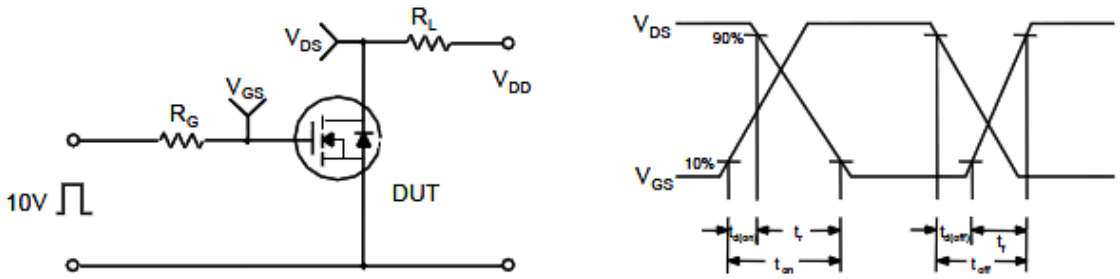
Normalized Thermal Transient Impedance, Junction-to-Ambient

Typical Characteristics (N-Channel)

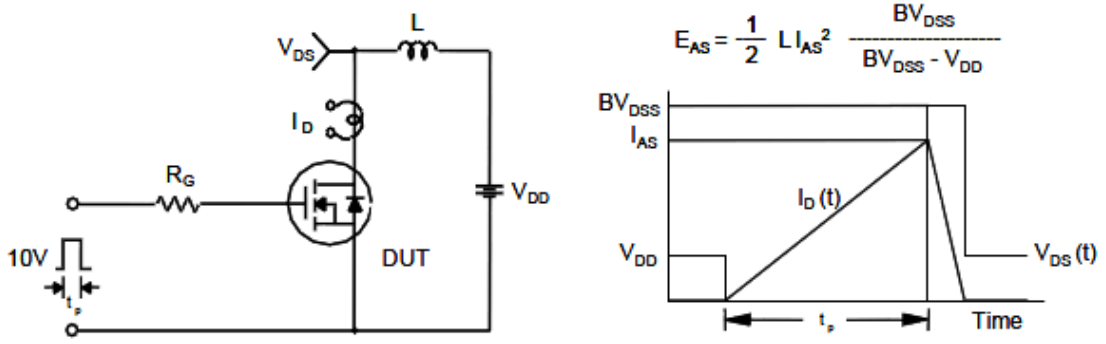
Gate Charge Test Circuit & Waveform



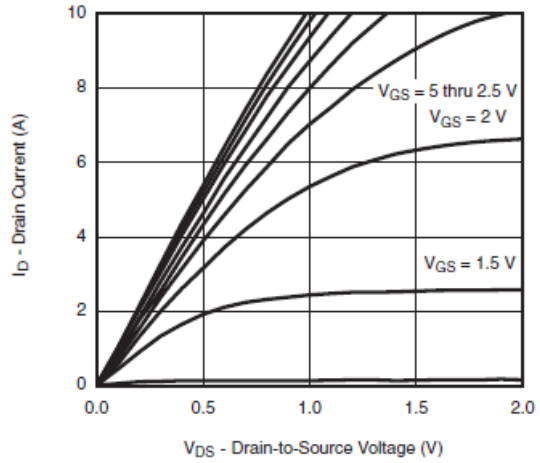
Resistive Switching Test Circuit & Waveforms



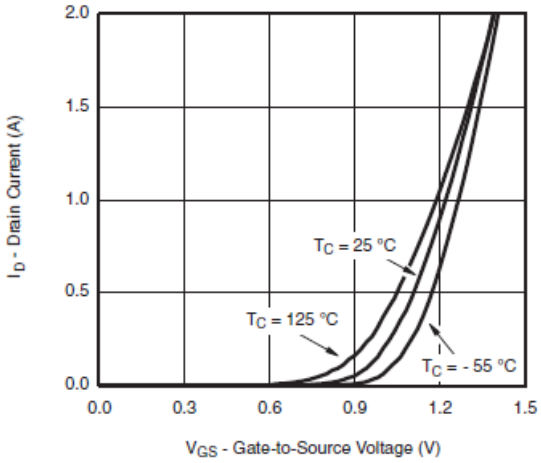
Unclamped Inductive Switching Test Circuit & Waveforms



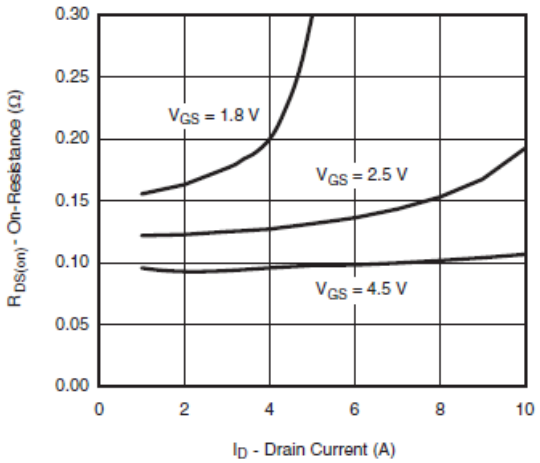
Typical Characteristics (P-Channel)



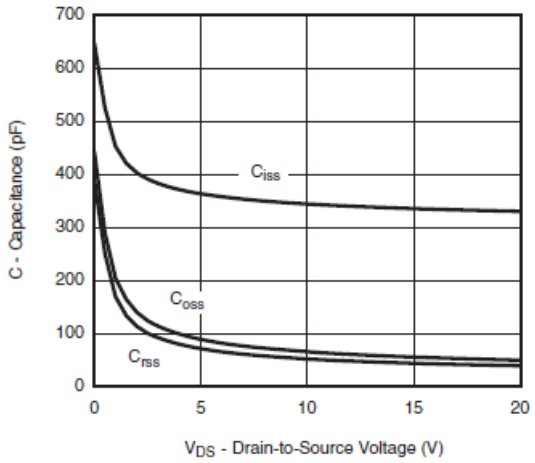
Output Characteristics



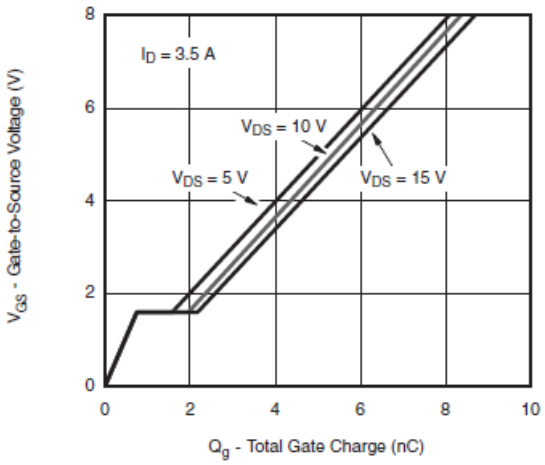
Transfer Characteristics



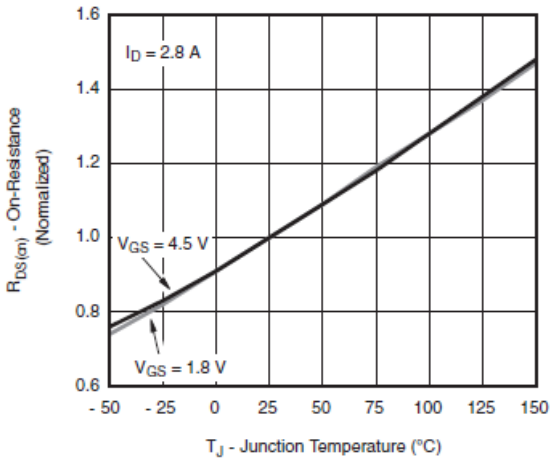
On-Resistance vs. Drain Current and Gate Voltage



Capacitance

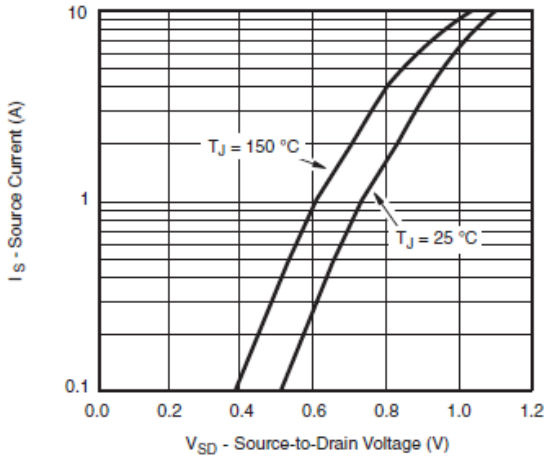


Gate Charge

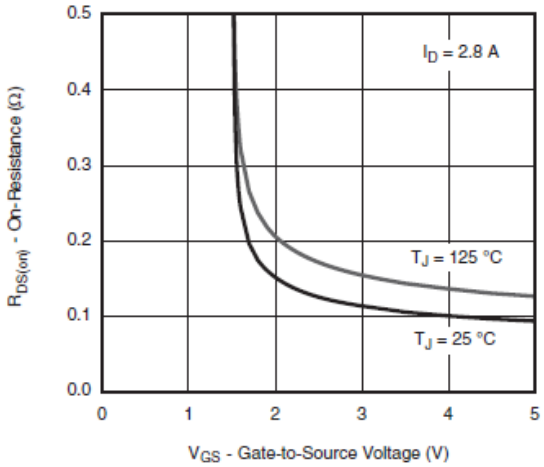


On-Resistance vs. Junction Temperature

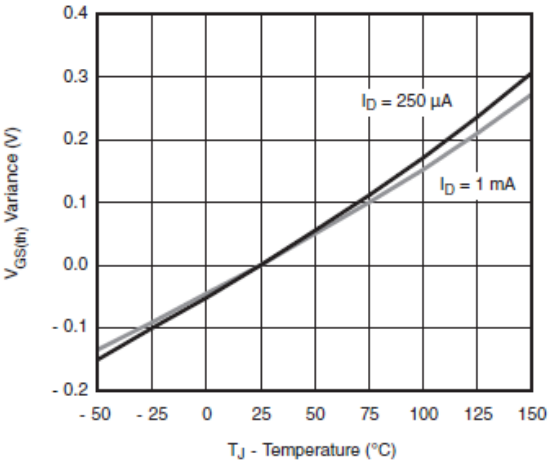
Typical Characteristics (P-Channel)



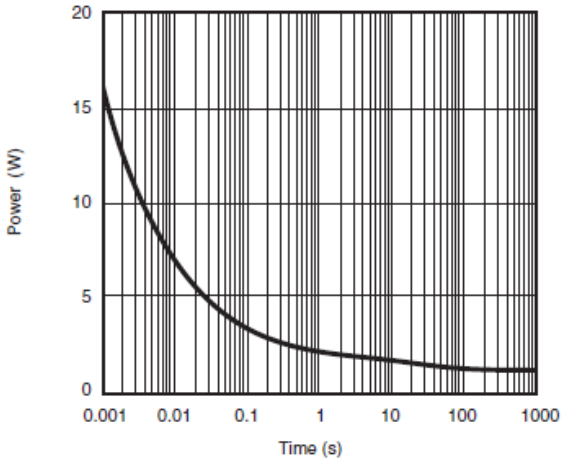
Soure-Drain Diode Forward Voltage



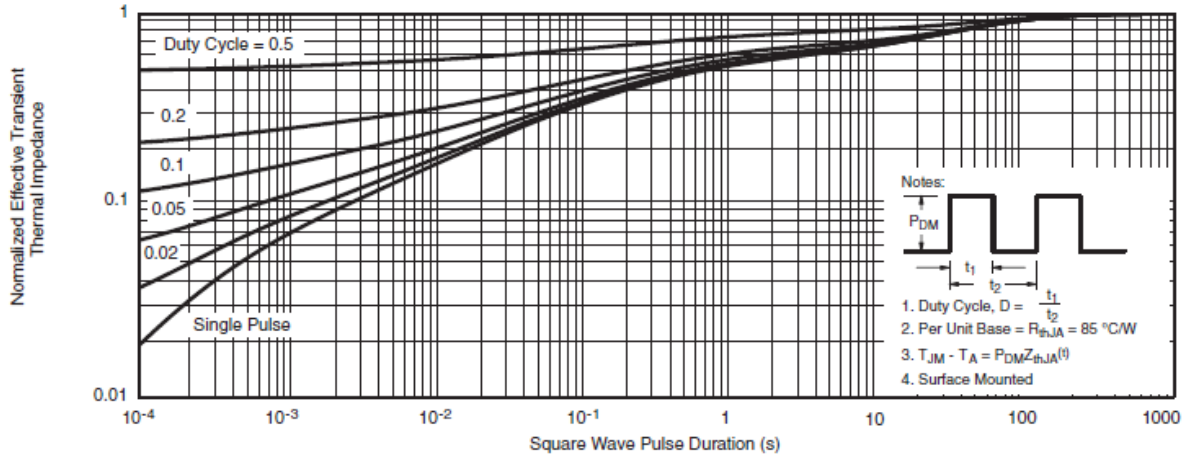
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



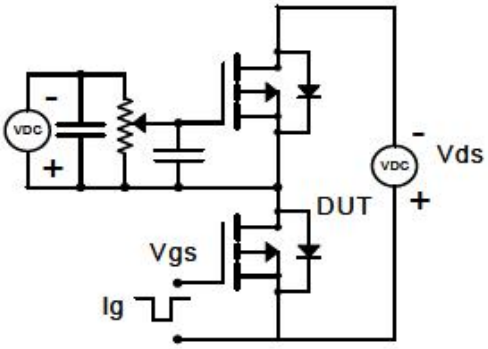
Single Pulse Power, Junction-to-Ambient

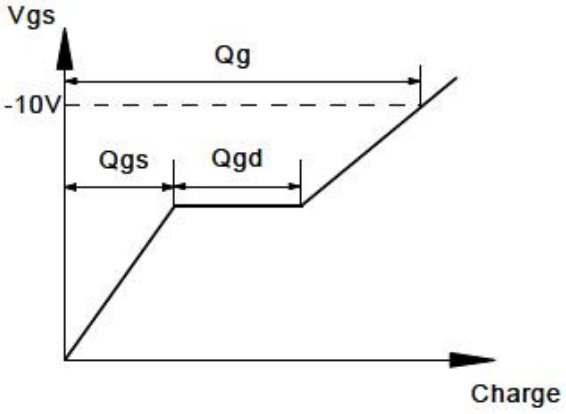


Normalized Thermal Transient Impedance, Junction-to-Ambient

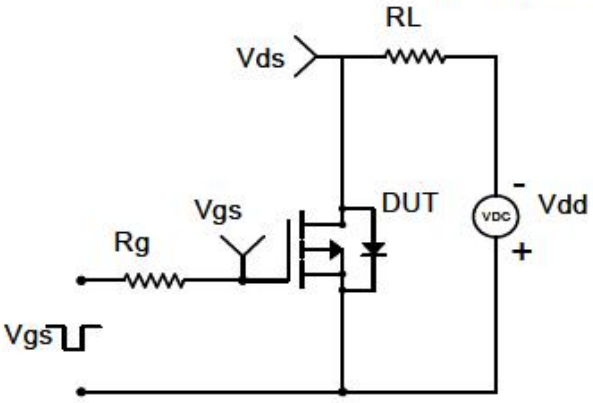
Typical Characteristics (P-Channel)

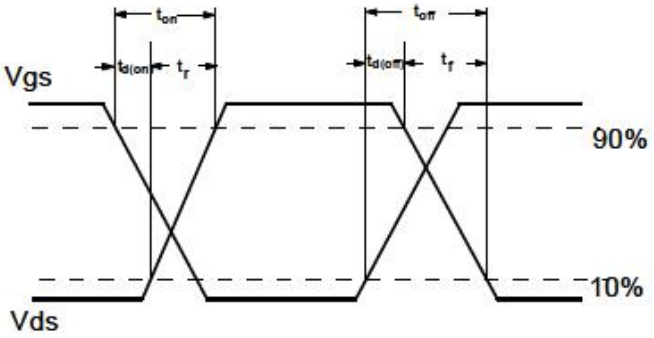
Gate Charge Test Circuit & Waveform



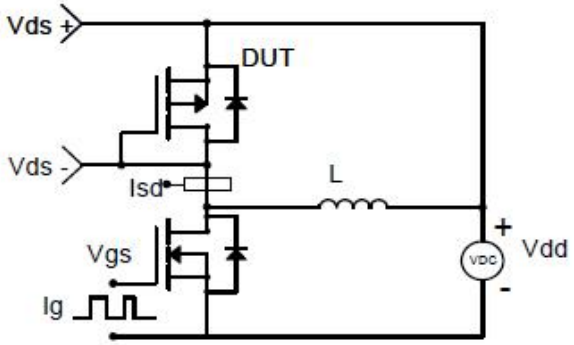


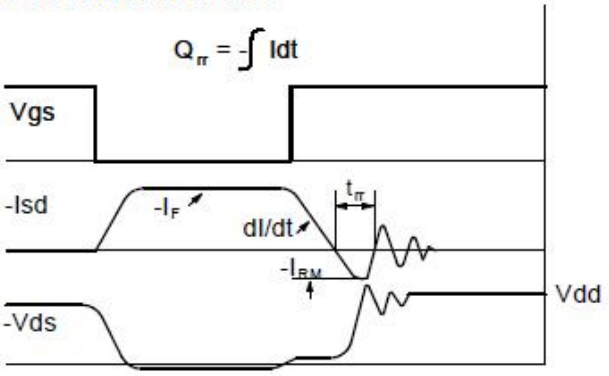
Resistive Switching Test Circuit & Waveforms



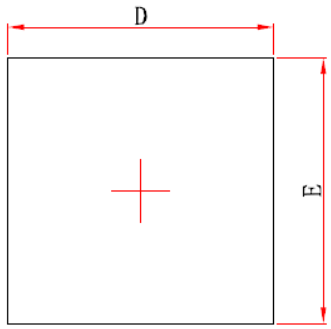


Diode Recovery Test Circuit & Waveforms

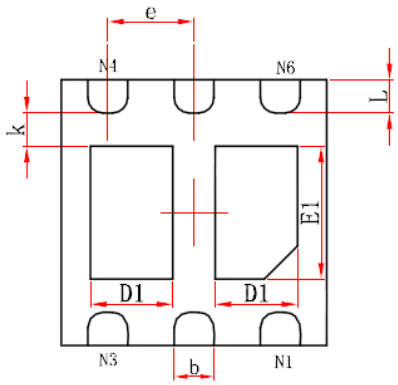




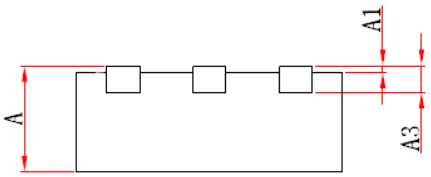
Package Information (DFN2X2-6L)



Top View



Bottom View



Side View

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.700	0.800	0.028	0.031
A1	0.000	0.050	0.000	0.002
A3	0.203REF.		0.008REF.	
D	1.924	2.076	0.076	0.082
E	2.924	3.076	0.115	0.121
D1	1.400	1.600	0.055	0.063
E1	1.400	1.600	0.055	0.063
k	0.200MIN.		0.008MIN.	
b	0.200	0.300	0.008	0.012
e	0.500TYP.		0.020TYP.	
L	0.224	0.376	0.009	0.015

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